**LMH1981 Multi-Format Video Sync Separator**

Check for Samples: LMH1981

**FEATURES**
- Standard Analog Video Sync Separation for NTSC, PAL, 480I/P, 576I/P, 720P, and 1080I/P/PsF from Composite Video (CVBS), S-Video (Y/C), and Component Video (YPbPr/GBR) Interfaces
- Bi-Level & Tri-Level Sync Compatible
- Composite, Horizontal, and Vertical Sync Outputs
- Burst/Back Porch Timing, Odd/Even Field, and Video Format Outputs
- Superior Jitter Performance on Leading Edge of HSync
- Automatic Video Format Detection
- 50% Sync Slicing for Video Inputs from 0.5 $V_{pp}$ to 2 $V_{pp}$
- 3.3V to 5V Supply Operation

**APPLICATIONS**
- Broadcast and Professional Video Equipment
- HDTV/DTV Systems
- Genlock Circuits
- Video Capture Devices
- Set-Top Boxes (STB) & Digital Video Recorders (DVR)
- Video Displays

**DESCRIPTION**

The LMH1981 is a high performance multi-format sync separator ideal for use in a wide range of video applications, such as broadcast and professional video equipment and HDTV/DTV systems.

The input accepts standard analog SD/ED/HD video signals with either bi-level or tri-level sync, and the outputs provide all of the critical timing signals in CMOS logic, which swing from rail-to-rail ($V_{CC}$ and GND) including Composite, Horizontal, and Vertical Syncs, Burst/Back Porch Timing, Odd/Even Field, and Video Format Outputs. HSync features very low jitter on its leading (falling) edge, minimizing external circuitry needed to clean and reduce jitter in subsequent clock generation stages.

The LMH1981 automatically detects the input video format, eliminating the need for programming using a microcontroller, and applies precise 50% sync slicing to ensure accurate sync extraction at $O_H$, even for inputs with irregular amplitude from improper termination or transmission loss. Its unique Video Format Output conveys the total horizontal line count per field as an 11-bit binary serial data stream, which can be decoded by the video system to determine the input video format and enable dynamic adjustment of system parameters, i.e.: color space or scaler conversions. The LMH1981 is available in a 14-pin TSSOP package and operates over a temperature range of $-40^\circ C$ to $+85^\circ C$.

**Connection Diagram**

![Connection Diagram](https://www.ti.com/lit/ds/slns214h/slns214h.pdf)

Figure 1. 14-Pin TSSOP - Top View

See PW Package

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## PIN DESCRIPTIONS

<table>
<thead>
<tr>
<th>Pin No.</th>
<th>Pin Name</th>
<th>Pin Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>R_{EXT}</td>
<td>Bias Current External Resistor</td>
</tr>
<tr>
<td>2, 5, 10</td>
<td>GND</td>
<td>Ground</td>
</tr>
<tr>
<td>3, 6, 11</td>
<td>V_{CC}</td>
<td>Supply Voltage</td>
</tr>
<tr>
<td>4</td>
<td>V_{IN}</td>
<td>Video Input</td>
</tr>
<tr>
<td>7</td>
<td>HSOUT</td>
<td>Horizontal Sync Output</td>
</tr>
<tr>
<td>8</td>
<td>VSOUT</td>
<td>Vertical Sync Output</td>
</tr>
<tr>
<td>9</td>
<td>VFOUT</td>
<td>Video Format Output</td>
</tr>
<tr>
<td>12</td>
<td>CSOUT</td>
<td>Composite Sync Output</td>
</tr>
<tr>
<td>13</td>
<td>BPOUT</td>
<td>Burst/Back Porch Timing Output</td>
</tr>
<tr>
<td>14</td>
<td>OEOUT</td>
<td>Odd/Even Field Output</td>
</tr>
</tbody>
</table>

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>ESD Tolerance (4)</th>
<th>Human Body Model</th>
<th>3.5 kV</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Machine Model</td>
<td>350V</td>
</tr>
<tr>
<td></td>
<td>Charge-Device Model</td>
<td>1.0 kV</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Supply Voltage, V_{CC}</th>
<th>0V to 5.5V</th>
</tr>
</thead>
</table>

| Video Input, V_{IN} | −0.3V to V_{CC} + 0.3V |

| Storage Temperature Range | −65°C to +150°C |

| Lead Temperature (soldering 10 sec.) | 300°C |

| Junction Temperature (T_{JMAX}) (5) | +150°C |

| Thermal Resistance (θ_{JA}) | 52°C/W |

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics Tables.

(2) All voltages are measured with respect to GND, unless otherwise specified.

(3) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.


(5) The maximum power dissipation is a function of T_{JMAX}. The maximum allowable power dissipation at any ambient temperature is P_{D} = (T_{JMAX} - T_{A})/θ_{JA}. All numbers apply for packages soldered directly onto a PC board.

### Operating Ratings

<table>
<thead>
<tr>
<th>Temperature Range (2)</th>
<th>−40°C to +85°C</th>
</tr>
</thead>
<tbody>
<tr>
<td>V_{CC}</td>
<td>3.3V –5% to 5V +5%</td>
</tr>
</tbody>
</table>

| Input Amplitude, V_{INAMPL} | 140 mV to V_{CC}−V_{INCLAMP} |

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics Tables.

(2) The maximum power dissipation is a function of T_{JMAX}. The maximum allowable power dissipation at any ambient temperature is P_{D} = (T_{JMAX} - T_{A})/θ_{JA}. All numbers apply for packages soldered directly onto a PC board.
Electrical Characteristics

Unless otherwise specified, all limits are ensured for $T_A = 25^\circ C, V_{CC} = V_{CC1} = V_{CC2} = V_{CC3} = 3.3V, R_{EXT} = 10 \, k\Omega \, 1\%$, $R_L = 10 \, k\Omega$, $C_L < 10 \, pF$. **Boldface** limits apply at the temperature extremes. See Figure 2.

### Symbol | Parameter | Conditions | Min (2) | Typ (3) | Max (2) | Units
--- | --- | --- | --- | --- | --- | ---
$I_{CC}$ | Supply Current | No input signal | $V_{CC} = 3.3V$ | 9.5 | 11.5 | mA
 | | | $V_{CC} = 5V$ | 11 | 13.5 | |

**Video Input Specifications**

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
--- | --- | --- | --- | --- | --- | ---
$V_{IN-SYNC}$ | Input Sync Amplitude | Amplitude from negative sync tip to video blanking level for SD/EDTV bi-level sync | 0.14 | 0.30 | 0.60 | $V_{PP}$
 | | (4)(5)(6) Amplitude from negative to positive sync tips for HDTV tri-level sync | 0.30 | 0.60 | 1.20 | |
$V_{IN-CLAMP}$ | Input Sync Tip Clamp Level | | 0.7 | | | V |
$V_{IN-SLICE}$ | Input Sync Slice Level | Level between video blanking & sync tip for SD/EDTV and between negative & positive sync tips for HDTV | | | 50 | % |

**Logic Output Specifications (8)**

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
--- | --- | --- | --- | --- | --- | ---
$V_{OL}$ | Output Logic 0 | See output load conditions above | $V_{CC} = 3.3V$ | 0.3 | | V |
 | | | $V_{CC} = 5V$ | 0.5 | | |
$V_{OH}$ | Output Logic 1 | See output load conditions above | $V_{CC} = 3.3V$ | 3.0 | | V |
 | | | $V_{CC} = 5V$ | 4.5 | | |
$T_{SYNC-LOCK}$ | Sync Lock Time | Time for the output signals to be correct after the video signal settles at $V_{IN}$ following a significant input change. See **START-UP TIME** for more information | | | 2 | V periods |
$T_{VSOUT}$ | Vertical Sync Output Pulse Width | See Figure 3, Figure 4, Figure 5, Figure 6, Figure 7, and Figure 8 for SDTV, EDTV & HDTV Vertical Interval Timing | | | 3 | H periods |

(1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that $T_J = T_A$. No ensured specification of parametric performance is indicated in the electrical tables under conditions of internal self-heating where $T_J > T_A$.

(2) Limits are 100% production tested at 25$^\circ$C. Limits over the operating temperature range are ensured through correlations using the Statistical Quality Control (SQC) method.

(3) Typical values represent the most likely parametric norm at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not ensured on shipped production material.

(4) $V_{IN-AMPL} + V_{IN-CLAMP}$ should not exceed $V_{CC}$.

(5) Tested with 480I signal.

(6) Maximum voltage offset between 2 consecutive input horizontal sync tips must be less than 25 m$V_{PP}$.

(7) Tested with 720P signal.

(8) Outputs are negative-polarity logic signal, except for odd/even field and video format outputs.
The LMH1981 test circuit is shown in Figure 2. The video generator should provide a low-noise, broadcast-quality signal over 75Ω coaxial cable which should be impedance-matched with a 75Ω load termination resistor to prevent unwanted signal distortion. The output waveforms should be monitored using a low-capacitance probe on an oscilloscope with at least 500 MHz bandwidth. See PCB LAYOUT CONSIDERATIONS for more information about signal and supply trace routing and component placement.
SDTV Vertical Interval Timing (NTSC, PAL, 480i, 576i)

Figure 3. NTSC Odd Field Vertical Interval

Figure 4. NTSC Even Field Vertical Interval
EDTV Vertical Interval Timing (480P, 576P)

HDTV Vertical Interval Timing (720P, 1080P)
HDTV Vertical Interval Timing (1080I)

Figure 7. 1080I Field 1 Vertical Interval

Figure 8. 1080I Field 2 Vertical Interval
SD/EDTV Horizontal Interval Timing

Figure 9. SD/EDTV Horizontal Interval with Bi-level Sync
Table 1. SDTV Horizontal Interval Timing Characteristics (NTSC, PAL, 480I, 576I)\(^{(1)(2)}\)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Typ</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>(td_{CSOUT})</td>
<td>Composite Sync Output Propagation Delay from Input Sync Reference ((O_H))</td>
<td>See Figure 9</td>
<td>475</td>
<td>ns</td>
</tr>
<tr>
<td></td>
<td></td>
<td>NTSC, 480I</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>PAL, 576I</td>
<td>525</td>
<td></td>
</tr>
<tr>
<td>(td_{HSOUT})</td>
<td>Horizontal Sync Output Propagation Delay from Input Sync Reference ((O_H))</td>
<td>See Figure 9(^{(1)})</td>
<td>40</td>
<td>ns</td>
</tr>
<tr>
<td></td>
<td></td>
<td>NTSC, 480I</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>PAL, 576I</td>
<td>60</td>
<td></td>
</tr>
<tr>
<td>(td_{BPOUT})</td>
<td>Burst/Back Porch Timing Output Propagation Delay from Input Sync Trailing Edge</td>
<td>See Figure 9</td>
<td>300</td>
<td>ns</td>
</tr>
<tr>
<td>(T_{HSOUT})</td>
<td>Horizontal Sync Output Pulse Width</td>
<td>See Figure 9</td>
<td>2.5</td>
<td>(\mu s)</td>
</tr>
<tr>
<td>(T_{BPOUT})</td>
<td>Burst/Back Porch Timing Output Pulse Width</td>
<td>See Figure 9</td>
<td>3.2</td>
<td>(\mu s)</td>
</tr>
</tbody>
</table>

(1) Note: HSync propagation delay variation less than \(\pm 3\) ns (typ) over 0°C to 70°C temperature range.
(2) \(V_{CC} = 3.3\) V, \(T_A = 25\)°C

Table 2. EDTV Horizontal Interval Timing Characteristics (480P, 576P)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Typ</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>(td_{CSOUT})</td>
<td>Composite Sync Output Propagation Delay from Input Sync Reference ((O_H))</td>
<td>See Figure 9</td>
<td>450</td>
<td>ns</td>
</tr>
<tr>
<td>(td_{HSOUT})</td>
<td>Horizontal Sync Output Propagation Delay from Input Sync Reference ((O_H))</td>
<td>See Figure 9</td>
<td>35</td>
<td>ns</td>
</tr>
<tr>
<td>(td_{BPOUT})</td>
<td>Burst/Back Porch Timing Output Propagation Delay from Input Sync Trailing Edge</td>
<td>See Figure 9</td>
<td>500</td>
<td>ns</td>
</tr>
<tr>
<td>(T_{HSOUT})</td>
<td>Horizontal Sync Output Pulse Width</td>
<td>See Figure 9</td>
<td>2.3</td>
<td>(\mu s)</td>
</tr>
<tr>
<td>(T_{BPOUT})</td>
<td>Burst/Back Porch Timing Output Pulse Width</td>
<td>See Figure 9</td>
<td>350</td>
<td>ns</td>
</tr>
</tbody>
</table>

HDTV Horizontal Interval Timing

Figure 10. HDTV Horizontal Interval with Tri-level Sync
### Table 3. HDTV Horizontal Interval Timing Characteristics (720P, 1080I)\(^{(1)}\)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Typ</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>(t_{dCSOUT})</td>
<td>Composite Sync Output Propagation Delay from Input Sync Leading Edge</td>
<td>See Figure 10</td>
<td>150</td>
<td>ns</td>
</tr>
<tr>
<td>(t_{dHSOUT})</td>
<td>Horizontal Sync Output Propagation Delay from Input Sync Reference ((O_H))</td>
<td>See Figure 10</td>
<td>30</td>
<td>ns</td>
</tr>
<tr>
<td>(t_{dBOUT})</td>
<td>Burst/Back Porch Timing Output Propagation Delay from Input Sync Trailing Edge</td>
<td>See Figure 10</td>
<td>720P</td>
<td>400 ns</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>1080P</td>
<td>300 ns</td>
</tr>
<tr>
<td>(T_{HSOUT})</td>
<td>Horizontal Sync Output Pulse Width</td>
<td>See Figure 10</td>
<td>720P</td>
<td>525 ns</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>1080P</td>
<td>475 ns</td>
</tr>
<tr>
<td>(T_{BPOUt})</td>
<td>Burst/Back Porch Timing Output Pulse Width</td>
<td>See Figure 10</td>
<td></td>
<td>350 ns</td>
</tr>
</tbody>
</table>

\(^{(1)}\) \(V_{CC} = 3.3V\), \(T_A = 25^\circ C\)
APPLICATION INFORMATION

GENERAL DESCRIPTION

The LMH1981 is designed to extract the timing information from various video formats with vertical serration and output the syncs and relevant timing signals in CMOS logic. Its high performance, advanced features and easy application make it ideal for broadcast and professional video systems where low jitter is a crucial parameter. The device can operate from a supply voltage between 3.3V and 5V. The only required external components are bypass capacitors at the power supply pins, an input coupling capacitor at pin 4, and a precision R_{EXT} resistor at pin 1. Refer to the test circuit in Figure 2.

R_{EXT} Resistor

The R_{EXT} external resistor establishes the internal bias current and precise reference voltage for the LMH1981. For optimal performance, R_{EXT} should be a 10 kΩ 1% precision resistor with a low temperature coefficient to ensure proper operation over a wide temperature range. Using a R_{EXT} resistor with less precision may result in reduced performance (like worse jitter performance, increased propagation delay variation, or reduced input sync amplitude range) against temperature, supply voltage, input signal, or part-to-part variations.

NOTE
The R_{EXT} resistor serves a different function than the “R_{SET} resistor” used in the LM1881 sync separator. In the older LM1881, the R_{SET} value was adjusted to accommodate different input line rates. For the LMH1981, the R_{EXT} value is fixed, and the device automatically detects the input line rate to support various video formats without electrical or physical intervention.

50% Sync Slicing

The LMH1981 features 50% sync slicing on HSync to provide accurate sync separation for video input amplitudes from 0.5 V_{PP} to 2 V_{PP}, which enables excellent HSync jitter performance even for improperly terminated or attenuated source signals and stability against variations in temperature. The sync separator is compatible with SD/EDTV bi-level and HDTV tri-level sync inputs. Bi-level syncs will be sliced at the 50% point between the video blanking level and negative sync tip, indicated by the input's sync timing reference or “O_H” in Figure 9. Tri-level syncs will be sliced at the 50% point between the negative and positive sync tips (or positive zero-crossing), indicated by O_H in Figure 10.

VIDEO INPUT

The LMH1981 supports sync separation for CVBS, Y (luma) from Y/C and YPbPr and G (sync on green) from GBR with either bi-level or tri-level sync, as specified in the following video standards.

- Composite Video (CVBS) and S-Video (Y/C):
  - SDTV: SMPTE 170M (NTSC), ITU-R BT.470 (PAL)
- Component Video (YPbPr/GBR):
  - SDTV: SMPTE 125M, SMPTE 267M, ITU-R BT.601 (480i, 576i)
  - EDTV: ITU-R BT.1358 (480P, 576P)
  - HDTV: SMPTE 296M (720P), SMPTE 274M (1080I/P), SMPTE RP 211 (1080PsF)

The LMH1981 does not support RGB formats that conform to VESA standards used for PC graphics.
Input Termination
The video source should be load terminated with a 75Ω resistor to ensure correct video signal amplitude and minimize signal distortion due to reflections. In extreme cases, the LMH1981 can handle unterminated or double-terminated input conditions, assuming 1 Vp-p signal amplitude for normal terminated video.

Input Coupling Capacitor
The input signal should be AC coupled to the V_in (pin 4) of the LMH1981 with a properly chosen coupling capacitor, C_in.

The primary consideration in choosing C_in is whether the LMH1981 will interface with video sources using an AC-coupled output stage. If AC-coupled video sources are expected in the end-application, then it’s recommended to choose a small C_in value such as 0.01 µF as prescribed in the next section. Other considerations such as HSync jitter performance and start-up time are practically fixed by the limited range of small C_in values. It’s important to note that video sources with AC-coupled outputs will introduce video-dependent jitter that cannot be remedied by the sync separator; moreover, this type of jitter is prevalent in sources with DC-coupled input/output stages.

When only DC-coupled video sources are expected, a larger C_in value can be chosen to minimize voltage droop and thus improve HSync jitter at the expense of increased start-up time as explained in START-UP TIME. A typical C_in value such as 1 µF will give excellent jitter performance and reasonable start-up time using a broadcast-quality DC-coupled video generator. For applications where low HSync jitter is not critical, C_in can be a small value to reduce start-up time.

START-UP TIME
When there is a significant change to the video input signal, such as sudden signal switching, signal attenuation (i.e.: additional termination via loop through) or signal gain (i.e.: disconnected end-of-line termination), the quiescent operation of the LMH1981 will be disrupted. During this dynamic input condition, the LMH1981 outputs may not be correct but will recover to valid signals after a predictable start-up time, which consists of an adjustable input settling time and a predetermined “sync lock time”.

Input Settling Time and Coupling Capacitor Selection
Following a significant input condition, the negative sync tip of the AC-coupled signal settles to the input clamp voltage as the coupling capacitor, C_in, recovers a quiescent DC voltage via the dynamic clamp current. Because C_in determines the input settling time, its capacitance value is critical when minimizing overall start-up time.

For example, a settling time of 8 ms can be expected for a typical C_in value of 1 µF when switching in a standard NTSC signal with no prior input. A smaller value yields shorter settling time at the expense of increased line droop voltage and consequently higher HSync jitter, whereas a larger one gives lower jitter but longer settling time. Settling time is proportional to the value of C_in, so doubling C_in will also double the settling time.

The value of C_in is a tradeoff between start-up time and jitter performance and therefore should be evaluated based on the application requirements. Figure 11 shows a graph of typical input-referred HSync jitter vs. C_in values to use as a guideline. Refer to Horizontal Sync Output for more about jitter performance.
Sync Lock Time

In addition to settling time, the LMH1981 has a predetermined sync lock time, $T_{\text{SYNC-LOCK}}$, before the outputs are correct. Once the AC-coupled input has settled enough, the LMH1981 needs time to detect the valid video signal and resolve the blanking & sync tip levels for 50% sync slicing before the output signals are correct.

For practical values of $C_{\text{IN}}$, $T_{\text{SYNC-LOCK}}$ is typically less than 1 or 2 video fields in duration starting from the 1st valid VSync output pulse to the valid HSync pulses beginning thereafter. VSync and HSync pulses are considered valid when they align correctly with the input's vertical and horizontal sync intervals. Note that the start-up time may vary depending on the video duty cycle, average picture level variations, and start point of video relative to the vertical sync interval.

It is recommended for the outputs to be applied to the system after the start-up time is satisfied and outputs are valid. For example, the oscilloscope screenshot in Figure 12 shows a typical start-up time of about 13.5 ms from when an NTSC signal is switched in (no previous input) to when the LMH1981 outputs are valid.

![Figure 12. Typical Start-Up Time for NTSC Input to LMH1981 via 1 µF Coupling Capacitor](image-url)
LOGIC OUTPUTS

In the absence of a video input signal, the LMH1981 outputs are logic high except for the odd/even field and video format outputs, which are both undefined, and the composite sync output.

Composite Sync Output

CSOUT (pin 12) simply reproduces the video input sync pulses below the video blanking level. This is obtained by clamping the video signal sync tip to the internal clamp voltage at $V_{IN}$ and extracting the resultant composite sync signal, or CSync. For both bi-level and tri-level syncs, CSync's negative-going leading edge is derived from the input's negative-going leading edge with a propagation delay.

Horizontal Sync Output

HSOUT (pin 7) produces a negative-polarity horizontal sync signal, or HSync, with very low jitter on its negative-going leading edge (reference edge) using precise 50% sync slicing. For bi-level and tri-level sync signals, the horizontal sync leading edge is triggered from the input's sync reference, $O_H$, with a propagation delay.

HSync was optimized for excellent jitter performance on its leading edge because most video systems are negative-edge triggered. When HSync is used in a positive-edge triggered system, like an FPGA PLL input, it must be inverted beforehand to produce positive-going leading edges. The trailing edge of HSync should never be used as the reference or triggered edge. This is because the trailing edges of HSync are reconstructed for the broad serration pulses during the vertical interval.

HSync's typical peak-to-peak jitter can be measured using the input-referred jitter test methodology on a real-time digital oscilloscope by triggering at or near the input's $O_H$ reference and monitoring HSync's leading edge with 4-sec. variable persistence. This is one way to measure HSync's typical peak-to-peak jitter in the time domain. Figure 13 and Figure 14 show oscilloscope screenshots demonstrating very low jitter on HSync's leading edge for 1080I tri-level sync and PAL Black Burst inputs, respectively, from a Tek TG700-AWVG7/AVG7 video generator with DC-coupled outputs and with LMH1981 $V_{CC} = 3.3V$.

Vertical Sync Output

VSOUT (pin 8) produces a negative-polarity vertical sync signal, or VSync. VSync's negative-going leading edge is derived from the 50% point of the first vertical serration pulse with a propagation delay, and its output pulse width, $T_{VSOUT}$, spans approximately three horizontal periods (3H).

Burst/Back Porch Timing Output

BPOUT (pin 13) provides a negative-polarity burst/back porch signal, which is pulsed low for a fixed width during the back porch interval following the input's sync pulse. The burst/back porch timing pulse is useful as a burst gate signal for NTSC/PAL color burst synchronization and as a clamp signal for black level clamping (DC restoration) and sync stripping applications.
For SDTV formats, the back porch pulse's negative-going leading edge is derived from the input's positive-going sync edge with a propagation delay, and the pulse width spans an appropriate duration of the color burst envelope for NTSC/PAL. During the vertical interval, its pulse width is shorter to correspond with the narrow serration pulses. For EDTV formats, the back porch pulse behaves similar to the SDTV case except that the shorter pulse width is always maintained. For HDTV formats, the pulse's leading edge is derived from the input's negative-going trailing sync edge with a propagation delay, and the pulse width is even narrower to correspond with the shortest back porch duration of HDTV formats.

Odd/Even Field Output

OEOUT (pin 14) provides an odd/even field output signal, which facilitates identification of odd and even fields for interlaced or segmented frame (sF) formats. For interlaced or segmented frame formats, the odd/even output is logic high during an odd field (field 1) and logic low during an even field (field 2). The odd/even output edge transitions align with VSync's leading edge to designate the start of odd and even fields. For progressive (non-interlaced) video formats, the output is held constantly at logic high.

Video Format Output (Lines-per-Field Data)

The LMH1981 counts the number of HSync pulses per field to approximate the total horizontal line count per field (vertical resolution). This can be used to identify the video format and enable dynamic adjustment of video system parameters, such as color space or scaler conversions. The line count per field is output to VFOUT (pin 9) as an 11-bit binary data stream. The video format data stream is clocked out on the 11 consecutive leading edges of HSync, starting at the 3rd HSync after each VSync leading edge. Outside of these active 11-bits of data, the video format output can be either 0 or 1 and should be treated as undefined. Refer to Figure 15 to see the VFOUT data timing for the 480P progressive format and Figure 16 and Figure 17 for the 1080I interlaced format. See Table 4 for a summary of VFOUT data for all supported formats.

A FPGA/MCU can be used to decode the 11-bit VFOUT data stream by using HSync as the clock source signal and VSync as the enable signal. Using the FPGA's clock delay capability, a delayed clock derived from HSync can be used as the sampling clock to latch the VFOUT data in the middle of the horizontal line period rather than near the VFOUT data-bit transitions in order to avoid setup time requirements.

<table>
<thead>
<tr>
<th>TV Format (Total Lines per Field)</th>
<th>VFOUT Data Field 1</th>
<th>VFOUT Data Field 2</th>
</tr>
</thead>
<tbody>
<tr>
<td>NTSC/480I (262.5)</td>
<td>00100000100b 260d</td>
<td>0010000011b 259d</td>
</tr>
<tr>
<td>PAL/576I (312.5)</td>
<td>00100110110b 310d</td>
<td>00100110101b 309d</td>
</tr>
<tr>
<td>480P (525)</td>
<td>0100001010b 522d</td>
<td>N/A</td>
</tr>
<tr>
<td>576P (625)</td>
<td>0100110111b 622d</td>
<td>N/A</td>
</tr>
<tr>
<td>720P (750)</td>
<td>0101110111b 747d</td>
<td>N/A</td>
</tr>
<tr>
<td>1080I (562.5)</td>
<td>0100011000b 560d</td>
<td>01000101111b 559d</td>
</tr>
<tr>
<td>1080P (1125)</td>
<td>10001100010b 1122d</td>
<td>N/A</td>
</tr>
</tbody>
</table>

(1) Note: VFOUT Data has an average offset of ~3 lines due to the HSync pulses uncounted during the VSync pulse interval.
Figure 15. Video Format Output for Progressive Format, 480P

Figure 16. Video Format Output for Interlaced Format, 1080I Field 1
OPTIONAL CONSIDERATIONS

Optional Input Filtering

An external filter may be necessary if the video signal has considerable high-frequency noise or has large chroma amplitude that extends near the sync tip. A simple RC low-pass filter with a series resistor (R_S) and a capacitor (C_F) to ground can be used to improve the overall signal-to-noise ratio and sufficiently attenuate chroma such that minimum peak of its amplitude is above the 50% sync slice level. To achieve the desired filter cutoff frequency, it’s advised to vary C_F and keep R_S small (i.e. 100Ω) to minimize sync tip clipping due to the voltage drop across R_S. Note that using an external filter will increase the propagation delay from the input to the outputs.

In applications where the chroma filter needs to be disabled when non-composite video (i.e.: ED/HD video) is input, it is possible to use a transistor to switch open C_F’s connection to ground as shown in Figure 18. This transistor can be switched off/on by logic circuitry to decode the lines-per-field data output (VFOUT). As shown in Table 4, NTSC and PAL both have 1 (logic high) for the 3rd bit of VFOUT. If the logic circuitry detects 0 (logic low) for this bit, indicating non-composite video, the transistor can be turned off to disable the chroma filter.

AC-Coupled Video Sources

An AC coupled video source typically has a 100 µF or larger output coupling capacitor (C_OUT) for protection and to remove the DC bias of the amplifier output from the video signal. When the video source is load terminated, the average value of the video signal will shift dynamically as the video duty cycle varies due to the averaging effect of the C_OUT and termination resistors. The average picture level or APL of the video content is closely related to the duty cycle.
For example, a significant decrease in APL such as a white-to-black field transition will cause a positive-going shift in the sync tips characterized by the source’s RC time constant, $t_{RC-OUT} (150 \Omega \times C_{OUT})$. The LMH1981’s input clamp circuitry may have difficulty stabilizing the input signal under this type of shifting; consequently, the unstable signal at $V_{IN}$ may cause missing sync output pulses to result, unless a proper value for $C_{IN}$ is chosen.

To avoid this potential problem when interfacing AC-coupled sources to the LMH1981, it’s necessary to introduce a voltage droop component via $C_{IN}$ to compensate for video signal shifting related to changes in the APL. This can be accomplished by selecting $C_{IN}$ such that the effective time constant of the LMH1981’s input circuit, $t_{RC-IN}$, is less than $t_{RC-OUT}$.

The effective time constant of the input circuit can be approximated as: $t_{RC-IN} = (R_S + R_I) \times C_{IN} \times T_{LINE} / T_{CLAMP}$, where $R_S = 150 \Omega$, $R_I = 4000 \Omega$ (input resistance), $T_{LINE} \sim 64 \mu s$ for NTSC, and $T_{CLAMP} = 250 \text{ns}$ (internal clamp duration). A white-to-black field transition in NTSC video through $C_{OUT}$ will exhibit the maximum sync tip shifting due to its long line period ($T_{LINE}$). By setting $t_{RC-IN} < t_{RC-OUT}$, the maximum value of $C_{IN}$ can be calculated to ensure proper operation under this worst-case condition.

For instance, $t_{RC-OUT}$ is about 33 ms for $C_{OUT} = 220 \mu F$. To ensure $t_{RC-IN} < 33 \text{ ms}$, $C_{IN}$ must be less than 31 nF. By choosing $C_{IN} = 0.01 \mu F$, the LMH1981 will function properly with AC-coupled video sources using $C_{OUT} \geq 220 \mu F$.

**PCB LAYOUT CONSIDERATIONS**

**LMH1981 IC Placement**

The LMH1981 should be placed such that critical signal paths are short and direct to minimize PCB parasitics from degrading the high-speed video input and logic output signals.

**Ground Plane**

A two-layer, FR-4 PCB is sufficient for this device. One of the PCB layers should be dedicated to a single, solid ground plane that runs underneath the device and connects the device GND pins together. The ground plane should be used to connect other components and serve as the common ground reference. It also helps to reduce trace inductances and minimize ground loops. Try to route supply and signal traces on another layer to maintain as much ground plane continuity as possible.

**Power Supply Pins**

The power supply pins should be connected together using short traces with minimal inductance. When routing the supply traces, be careful not to disrupt the solid ground plane.

For high frequency bypassing, place 0.1 \mu F SMD ceramic bypass capacitors with very short connections to power supply and GND pins. Two or three ceramic bypass capacitors can be used depending on how the supply pins are connected together. Place a 4.7 \mu F SMD tantalum bypass capacitor nearby all three power supply pins for low frequency supply bypassing.

**$R_{EXT}$ Resistor**

The $R_{EXT}$ resistor should be a 10 k\Omega 1% SMD precision resistor. Place $R_{EXT}$ as close as possible to the device and connect to pin 1 and the ground plane using the shortest possible connections. All input and output signals must be kept away from this pin to prevent unwanted signals from coupling into this pin.

**Video Input**

The input signal path should be routed using short, direct traces between video source and input pin. Use a 75\Omega input termination and a SMD capacitor for AC coupling the video input to pin 4.

**Output Routing**

The output signal paths should be routed using short, direct traces to minimize parasitic effects that may degrade these high-speed logic signals. All output signals should have a resistive load of about 10 k\Omega and capacitive load of less than 10 pF, including parasitic capacitances for optimal signal quality. This is especially important for the horizontal sync output, in which it is critical to minimize timing jitter. Each output can be protected by current limiting with a small series resistor, like 100\Omega.
## REVISION HISTORY

**Changes from Revision G (March 2013) to Revision H**

<table>
<thead>
<tr>
<th>Change Description</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>Changed layout of National Data Sheet to TI format</td>
<td>18</td>
</tr>
</tbody>
</table>
## PACKAGING INFORMATION

<table>
<thead>
<tr>
<th>Orderable Device</th>
<th>Status (1)</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>Package Qty</th>
<th>Eco Plan (2)</th>
<th>Lead/Ball Finish</th>
<th>MSL Peak Temp (3)</th>
<th>Op Temp (°C)</th>
<th>Top-Side Markings (4)</th>
</tr>
</thead>
<tbody>
<tr>
<td>LMH1981MT/NOPB</td>
<td>ACTIVE</td>
<td>TSSOP</td>
<td>PW</td>
<td>14</td>
<td>94</td>
<td>Green (RoHS &amp; no Sb/Br)</td>
<td>CU SN</td>
<td>Level-1-260C-UNLIM</td>
<td>-40 to 85</td>
<td>LMH1981MT</td>
</tr>
<tr>
<td>LMH1981MTX/NOPB</td>
<td>ACTIVE</td>
<td>TSSOP</td>
<td>PW</td>
<td>14</td>
<td>2500</td>
<td>Green (RoHS &amp; no Sb/Br)</td>
<td>CU SN</td>
<td>Level-1-260C-UNLIM</td>
<td>-40 to 85</td>
<td>LMH1981MTX</td>
</tr>
</tbody>
</table>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check [http://www.ti.com/productcontent](http://www.ti.com/productcontent) for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp.-- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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## TAPE AND REEL INFORMATION

### TAPE DIMENSIONS

<table>
<thead>
<tr>
<th>Dimension</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>A0</td>
<td>Dimension designed to accommodate the component width</td>
</tr>
<tr>
<td>B0</td>
<td>Dimension designed to accommodate the component length</td>
</tr>
<tr>
<td>K0</td>
<td>Dimension designed to accommodate the component thickness</td>
</tr>
<tr>
<td>W</td>
<td>Overall width of the carrier tape</td>
</tr>
<tr>
<td>P1</td>
<td>Pitch between successive cavity centers</td>
</tr>
</tbody>
</table>

### REEL DIMENSIONS

- Reel Diameter
- Reel Width (W1)

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

- Sprocket Holes
- User Direction of Feed
- Pocket Quadrants

*All dimensions are nominal*

<table>
<thead>
<tr>
<th>Device</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>SPQ</th>
<th>Reel Diameter (mm)</th>
<th>Reel Width W1 (mm)</th>
<th>A0  (mm)</th>
<th>B0  (mm)</th>
<th>K0  (mm)</th>
<th>P1  (mm)</th>
<th>W  (mm)</th>
<th>Pin1 Quadrant</th>
</tr>
</thead>
<tbody>
<tr>
<td>LMH1981MTX/NOPB</td>
<td>TSSOP</td>
<td>PW</td>
<td>14</td>
<td>2500</td>
<td>330.0</td>
<td>12.4</td>
<td>6.95</td>
<td>5.6</td>
<td>1.6</td>
<td>8.0</td>
<td>12.0</td>
<td>Q1</td>
</tr>
</tbody>
</table>
### TAPE AND REEL BOX DIMENSIONS

<table>
<thead>
<tr>
<th>Device</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>SPQ</th>
<th>Length (mm)</th>
<th>Width (mm)</th>
<th>Height (mm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>LMH1981MTX/NOPB</td>
<td>TSSOP</td>
<td>PW</td>
<td>14</td>
<td>2500</td>
<td>367.0</td>
<td>367.0</td>
<td>35.0</td>
</tr>
</tbody>
</table>

*All dimensions are nominal*
NOTES:
A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.25 each side.
E. Falls within JEDEC MO-153
NOTES:  
A. All linear dimensions are in millimeters.  
B. This drawing is subject to change without notice.  
C. Publication IPC-7351 is recommended for alternate designs.  
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.  
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.
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